

## CY7C1019B CY7C10191B

# 128K x 8 Static RAM

#### Features

- High speed
  - t<sub>AA</sub> = 10, 12, 15 ns
- · CMOS for optimum speed/power
- Center power/ground pinout
- Automatic power-down when deselected
- Easy memory expansion with  $\overline{CE}$  and  $\overline{OE}$  options
- Functionally equivalent to CY7C1019

#### **Functional Description**

The CY7C1019B/10191B is a high-performance CMOS static RAM organized as 131,072 words by 8 bits. Easy <u>memory</u> expansion is provided by an <u>active LOW Chip Enable (CE)</u>, an active LOW Output Enable (OE), and three-state drivers. This device has an automatic power-down feature that significantly reduces power consumption when deselected.



Reading from the device is accomplished by taking Chip Enable ( $\overline{\text{CE}}$ ) and Output Enable ( $\overline{\text{OE}}$ ) LOW while forcing Write Enable (WE) HIGH. Under these conditions, the contents of the memory location specified by the address pins will appear on the I/O pins.

The eight input/output pins (I/O<sub>0</sub> through I/O<sub>7</sub>) are placed in <u>a</u> high-impedance state when the <u>device</u> is deselected ( $\overline{CE}$  HIGH), the <u>outputs</u> are disabled ( $\overline{OE}$  HIGH), or during a write operation ( $\overline{CE}$  LOW, and  $\overline{WE}$  LOW).

The CY7C1019B/10191B is available in standard 32-pin TSOP Type II and 400-mil-wide SOJ packages. Customers should use part number CY7C10191B when ordering parts with 10 ns  $t_{AA}$ , and CY7C1019B when ordering 12 and 15 ns  $t_{AA}.$ 





#### **Selection Guide**

		7C10191B-10	7C1019B-12	7C1019B-15	Unit
Maximum Access Time		10	12	15	ns
Maximum Operating Current		150	140	130	mA
Maximum Standby Current		10	10	10	mA
	L	-	1	1	mA

#### **Maximum Ratings**

(Above which the useful life may be impaired. For user guide- lines, not tested.)
Storage Temperature65°C to +150°C
Ambient Temperature with Power Applied55°C to +125°C
Supply Voltage on V <sub>CC</sub> to Relative GND <sup>[1]</sup> –0.5V to +7.0V
DC Voltage Applied to Outputs in High Z State <sup>[1]</sup> 0.5V to $V_{CC}$ + 0.5V
DC Input Voltage <sup>[1]</sup> –0.5V to V <sub>CC</sub> + 0.5V

Current into Outputs (LOW)	20 mA
Static Discharge Voltage (per MIL-STD-883, Method 3015)	>2001V
Latch-Up Current	>200 mA

## **Operating Range**

Range	Ambient Temperature <sup>[2]</sup>	v <sub>cc</sub>
Commercial	0°C to +70°C	$5V\pm10\%$
Industrial	–40°C to +85°C	$5V\pm10\%$

## Electrical Characteristics Over the Operating Range

				7C101	91B-10	7C101	9B-12	7C101	I9B-15	
Parameter	Description	Test Conditions		Min.	Max.	Min.	Max.	Min.	Max.	Unit
V <sub>OH</sub>	Output HIGH Voltage	$V_{CC} = Min.,$ $I_{OH} = -4.0 \text{ mA}$		2.4		2.4		2.4		V
V <sub>OL</sub>	Output LOW Voltage	V <sub>CC</sub> = Min., I <sub>OL</sub> = 8.0 mA			0.4		0.4		0.4	V
V <sub>IH</sub>	Input HIGH Voltage			2.2	V <sub>CC</sub> + 0.3	2.2	V <sub>CC</sub> + 0.3	2.2	V <sub>CC</sub> + 0.3	V
V <sub>IL</sub>	Input LOW Voltage <sup>[1]</sup>			-0.3	0.8	-0.3	0.8	-0.3	0.8	V
I <sub>IX</sub>	Input Load Current	$GND \leq V_I \leq V_{CC}$		-1	+1	-1	+1	-1	+1	μA
I <sub>OZ</sub>	Output Leakage Current	$GND \leq V_I \leq V_{CC},$ Output Disabled		-5	+5	-5	+5	-5	+5	μΑ
I <sub>CC</sub>	V <sub>CC</sub> Operating Supply Current	$V_{CC} = Max.,$ $I_{OUT} = 0 mA,$ $f = f_{MAX} = 1/t_{RC}$			150		140		130	mA
I <sub>SB1</sub>	Automatic CE	Max. $V_{CC}$ , $\overline{CE} \ge V_{IH}$			40		40		40	mA
	Power-Down Current —TTL Inputs	$V_{IN} \ge V_{IH} \text{ or}$ $V_{IN} \le V_{IL}, f = f_{MAX}$	L		20		20		20	]
I <sub>SB2</sub>	Automatic CE	Max. V <sub>CC</sub> ,			10		10		10	mA
	Power-Down Current —CMOS Inputs	$\begin{array}{l} \text{CE} \geq V_{CC} - 0.3\text{V}, \\ \text{V}_{\text{IN}} \geq V_{CC} - 0.3\text{V}, \\ \text{or } V_{\text{IN}} \leq 0.3\text{V}, \text{f} = 0 \end{array}$	L		-		1		1	

## Capacitance<sup>[3]</sup>

Parameter	Description	Test Conditions	Max.	Unit
C <sub>IN</sub>	Input Capacitance	$T_A = 25^{\circ}C, f = 1 \text{ MHz},$	6	pF
C <sub>OUT</sub>	Output Capacitance	$V_{CC} = 5.0V$	8	pF

Notes:

V<sub>IL</sub> (min.) = -2.0V for pulse durations of less than 20 ns.
 T<sub>A</sub> is the "Instant On" case temperature.
 Tested initially and after any design or process changes that may affect these parameters.



## AC Test Loads and Waveforms



Equivalent to: THÉVENIN EQUIVALENT OUTPUT O-

Switching Characteristics<sup>[4]</sup> Over the Operating Range

		7C101	91B-10	7C10 <sup>-</sup>	19B-12	7C10 <sup>-</sup>	19B-15	
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Unit
Read Cycle			1		1		1	
t <sub>RC</sub>	Read Cycle Time	10		12		15		ns
t <sub>AA</sub>	Address to Data Valid		10		12		15	ns
t <sub>OHA</sub>	Data Hold from Address Change	3		3		3		ns
t <sub>ACE</sub>	CE LOW to Data Valid		10		12		15	ns
t <sub>DOE</sub>	OE LOW to Data Valid		5		6		7	ns
t <sub>LZOE</sub>	OE LOW to Low Z	0		0		0		ns
t <sub>HZOE</sub>	OE HIGH to High Z <sup>[5, 6]</sup>		5		6		7	ns
t <sub>LZCE</sub>	CE LOW to Low Z <sup>[6]</sup>	3		3		3		ns
t <sub>HZCE</sub>	CE HIGH to High Z <sup>[5, 6]</sup>		5		6		7	ns
t <sub>PU</sub>	CE LOW to Power-Up	0		0		0		ns
t <sub>PD</sub>	CE HIGH to Power-Down		10		12		15	ns
Write Cycle	7, 8]	•						_
t <sub>WC</sub>	Write Cycle Time	10		12		15		ns
t <sub>SCE</sub>	CE LOW to Write End	8		9		10		ns
t <sub>AW</sub>	Address Set-Up to Write End	7		8		10		ns
t <sub>HA</sub>	Address Hold from Write End	0		0		0		ns
t <sub>SA</sub>	Address Set-Up to Write Start	0		0		0		ns
t <sub>PWE</sub>	WE Pulse Width	7		8		10		ns
t <sub>SD</sub>	Data Set-Up to Write End	5		6		8		ns
t <sub>HD</sub>	Data Hold from Write End	0		0		0		ns
t <sub>LZWE</sub>	WE HIGH to Low Z <sup>[6]</sup>	3		3		3		ns
t <sub>HZWE</sub>	WE LOW to High Z <sup>[5, 6]</sup>		5		6		7	ns

Notes:

4. Test conditions assume signal transition time of 3 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V, and output loading of the specified I<sub>OL</sub>/I<sub>OH</sub> and 30-pF load capacitance.

5. t<sub>HZOE</sub>, t<sub>HZCE</sub>, and t<sub>HZWE</sub> are specified with a load capacitance of 5 pF as in part (b) of AC Test Loads. Transition is measured ±500 mV from steady-state voltage.

 A tagget, HzCE, HzCE, and HzWE are opening with the application of the set 8. The minimum write cycle time for Write Cycle no. 3 (WE controlled, OE LOW) is the sum of t<sub>HZWE</sub> and t<sub>SD</sub>.



Parameter	Description	Conditions	Min.	Max.	Unit
V <sub>DR</sub>	V <sub>CC</sub> for Data Retention	No input may exceed V <sub>CC</sub> + 0.5V	2.0		V
I <sub>CCDR</sub>	Data Retention Current	$\frac{V_{CC}}{CE} = V_{DR} = 2.0V,$ $\frac{CE}{CE} \ge V_{CC} - 0.3V,$		300	μA
t <sub>CDR</sub> <sup>[3]</sup>	Chip Deselect to Data Retention Time	$V_{\rm IN} \ge V_{\rm CC} - 0.3V$ or $V_{\rm IN} \le 0.3V$	0		ns
t <sub>R</sub>	Operation Recovery Time	1	200		μS

#### Data Retention Characteristics Over the Operating Range (L Version Only)

#### **Data Retention Waveform**



#### **Switching Waveforms**

Read Cycle No. 1<sup>[9, 10]</sup>





#### Read Cycle No. 2 (OE Controlled)<sup>[10, 11]</sup>

#### Notes:

10. WE is HIGH for read cycle.

11. Address valid prior to or coincident with  $\overline{CE}$  transition LOW.

<sup>9. &</sup>lt;u>Dev</u>ice is continuously selected.  $\overline{OE}$ ,  $\overline{CE} = V_{IL}$ .



#### Switching Waveforms (continued)

Write Cycle No. 1 ( $\overline{CE}$  Controlled)<sup>[12, 13]</sup>



Write Cycle No. 2 (WE Controlled, OE HIGH During Write)<sup>[12, 13]</sup>



**Notes:** 12. Data I/O is high impedance if  $\overline{OE} = V_{|H|}$ . 13. If CE goes HIGH simultaneously with WE going HIGH, the output remains in a high-impedance state. 14. During this period the I/Os are in the output state and input signals should not be applied.



## Switching Waveforms (continued)





## **Truth Table**

CE	OE	WE	I/O <sub>0</sub> –I/O <sub>7</sub>	Mode	Power
Н	Х	Х	High Z	Power-Down	Standby (I <sub>SB</sub> )
Х	Х	Х	High Z	Power-Down	Standby (I <sub>SB</sub> )
L	L	Н	Data Out	Read	Active (I <sub>CC</sub> )
L	Х	L	Data In	Write	Active (I <sub>CC</sub> )
L	Н	Н	High Z	Selected, Outputs Disabled	Active (I <sub>CC</sub> )

## **Ordering Information**

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
12	CY7C1019B-12VC	V33	32-Lead 400-Mil Molded SOJ	Commercial
	CY7C1019B-12ZC	ZS32	32-Lead TSOP Type II	
	CY7C1019B-12ZXC	ZS32	32-Lead TSOP Type II (Pb -Free )	
15	CY7C1019B-15VC	V33	32-Lead 400-Mil Molded SOJ	Commercial
	CY7C1019B-15VI	V33	32-Lead 400-Mil Molded SOJ	Industrial
	CY7C1019B-15ZC	ZS32	32-Lead TSOP Type II	Commercial
	CY7C1019B-15ZXC	ZS32	32-Lead TSOP Type II (Pb -Free)	
	CY7C1019B-15ZI	ZS32	32-Lead TSOP Type II	Industrial
Please contac	t local sales representative regarding	availability of par	rts	



#### Package Diagrams



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Document #: 38-05026 Rev. \*B

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## **Document History Page**

	ent Number:			x 8 Static RAM
REV.	ECN NO.	Issue Date	Orig. of Change	Description of Change
**	109949	09/25/01	SZV	Change from Spec number: 38-01115 to 38-05026
*A	116170	08/14/02	HGK	<ol> <li>SOJ (400-mil) package outline replacing incorrect SOJ package</li> <li>Pin for pin compatible with CY7C1019</li> <li>Industrial packages added to Ordering Information</li> </ol>
*В	397875	See ECN	NXR	Changed address of Cypress Semiconductor Corporation on Page# 1 from "3901 North First Street" to "198 Champion Court" Updated the Ordering Information Table on page # 6.